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Fujitsu and Asetek announce a global purchase agreement bringing Asetek RackCDU D2C liquid cooling technology to the Fujitsu High Performance Computing (HPC) server product portfolio.



Acetek claims RackCDU cooling can help datacentres save over 50% of cooling power and around 21% of overall energy use. It also allows a 2.5-5x increase in server density, thus eliminating the need for expensive build outs.

“This agreement is a significant milestone for Asetek and its stakeholders,” Asetek says. “Our collaboration with Fujitsu ushers in a new stage in the adoption of RackCDU. With its global reach and industry position, Fujitsu is poised to drive adoption of Asetek liquid cooling in data centers worldwide.”

The first Asetek-equipped Fujitsu servers launch during Q2 2015.

Go Asetek Announces Global OEM Purchase Agreement with Fujitsu